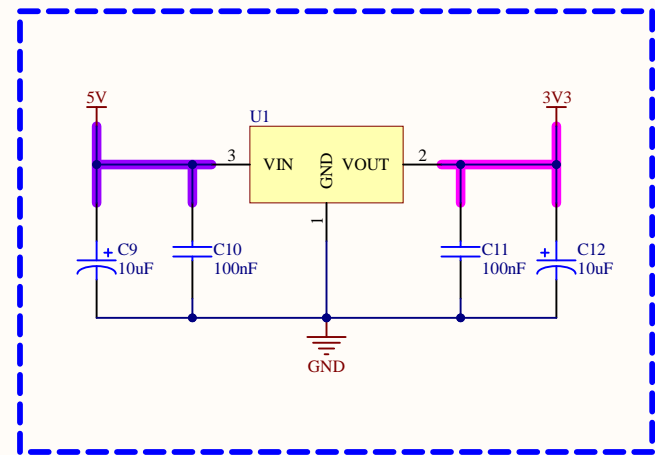
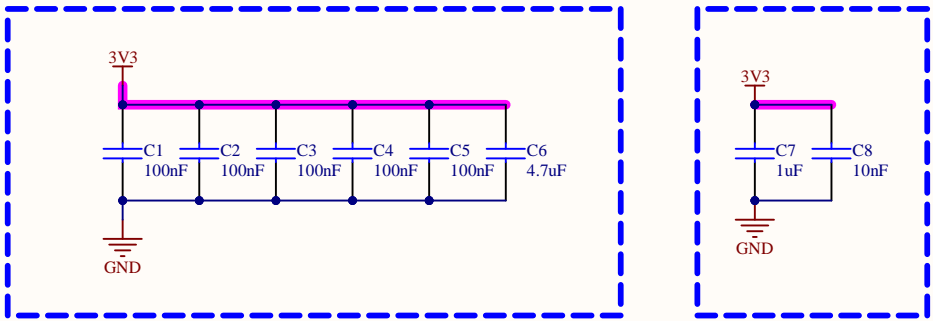


REGULATOR CIRCUIT



5V IN - 3.3V OUT

POWER CAPACITORS



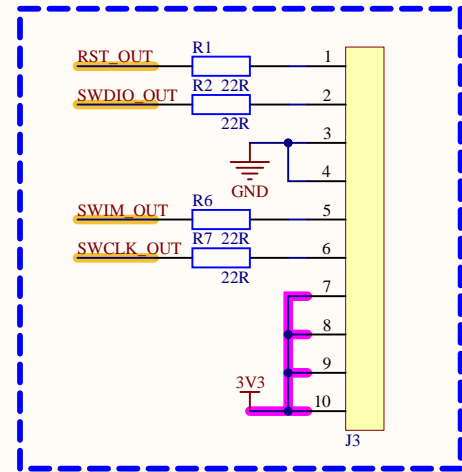
VDD

VDDA

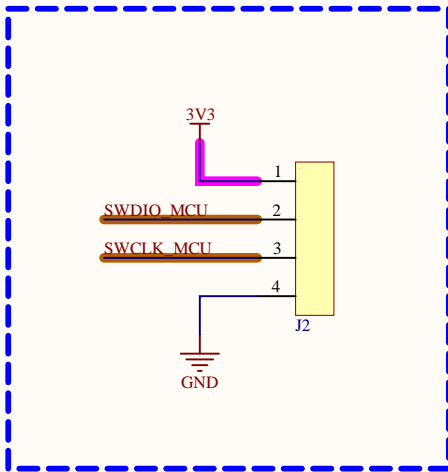
Decoupling capacitors should be placed as close to the MCU as possible.

Configuration of all capacitors have made from the datasheet used as reference.

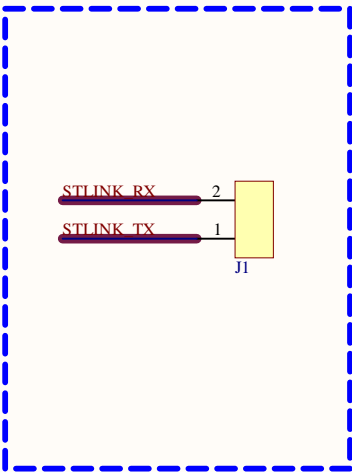
TERMINALS



STLINK OUT

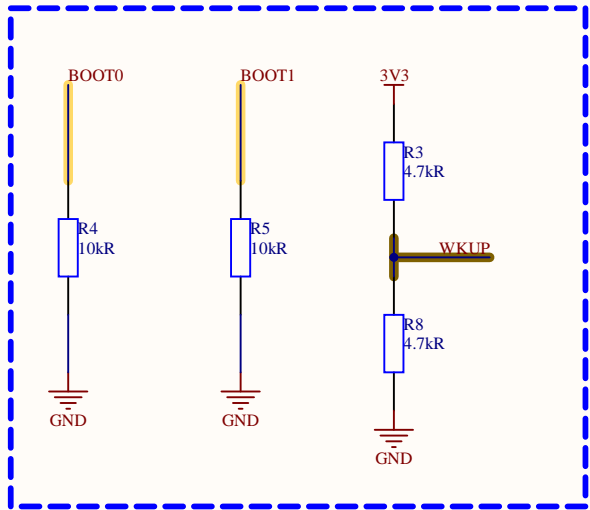


MCU PROGRAMMING



STLINK COM.

PULL UP&DOWN VOLTAGE DIVIDER RESISTORS



BOOT & WAKEUP PIN

The original design includes 10kR pull-down resistors for BOOTx pins. These pins are about the memory using.

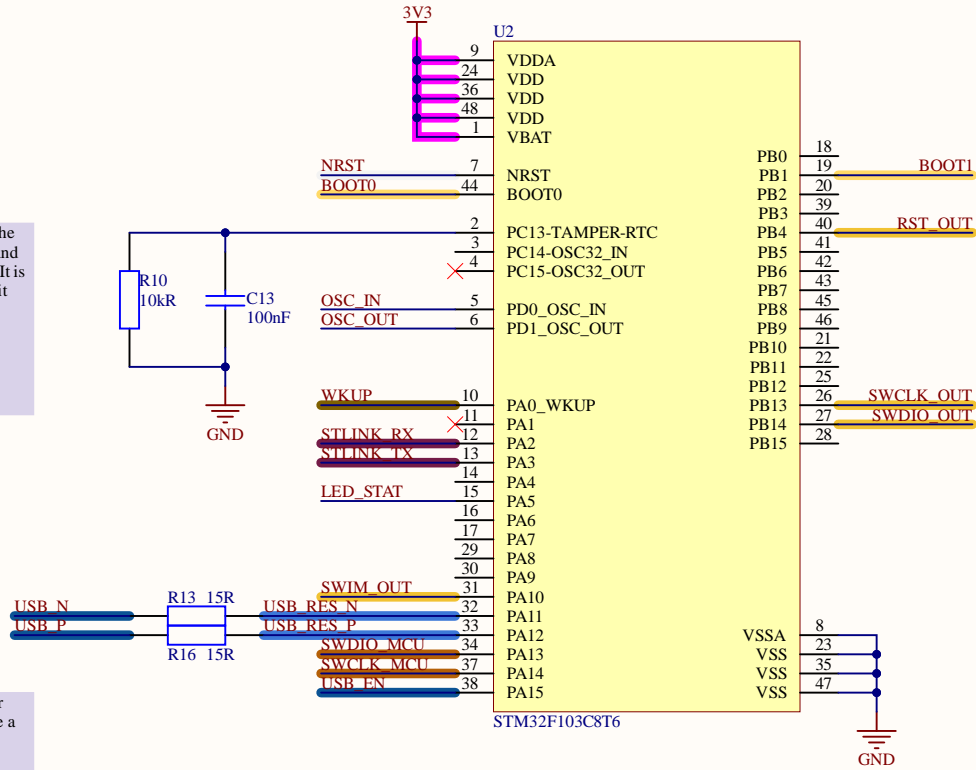
DOSYA ADI / FILE NAME PowerManagement.SchDoc		TANIM / DESCRIPTION STLINK_V2	
Aslı Kurt		HAZIRLAYAN / PREPARED BY Aslı Kurt	
		YAYIN TARİHİ / REL. DATE 30.10.2024	BOYUT / SIZE A3 SAYFA / SHEET 3 / 5

STM32 CIRCUIT

TAMPER pin detects the changes on the MCU and records the clock info. It is used for security. And it also works with RTC.

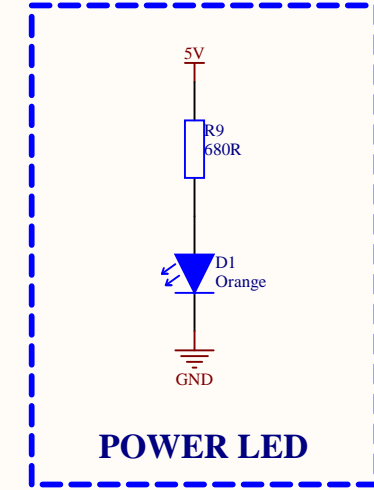
Using 15R resistors for USB Data Pins became a standard.

The tracing should be include differential methods and mpedans matching to enable appropriate communication process.

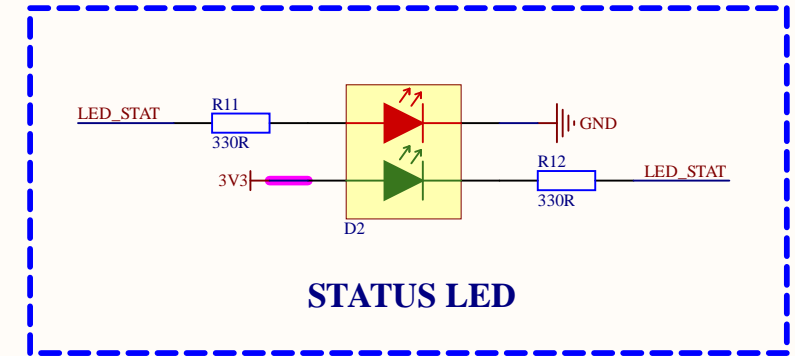


STM32F103C8T6

OUTPUTS



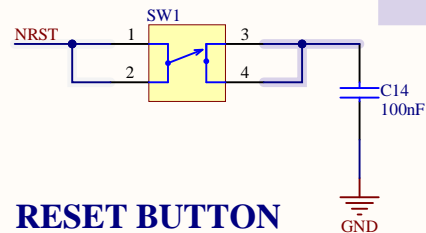
POWER LED



STATUS LED

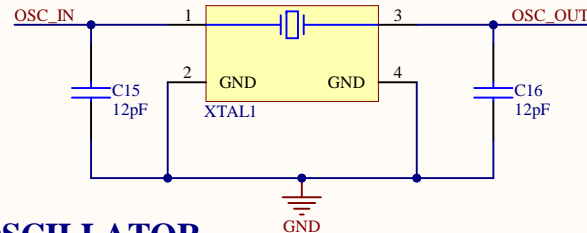
BUTTON & OSCILLATOR

NRST has ALREADY conected to 3V3 with pull-up resistor INTERNAL.



RESET BUTTON

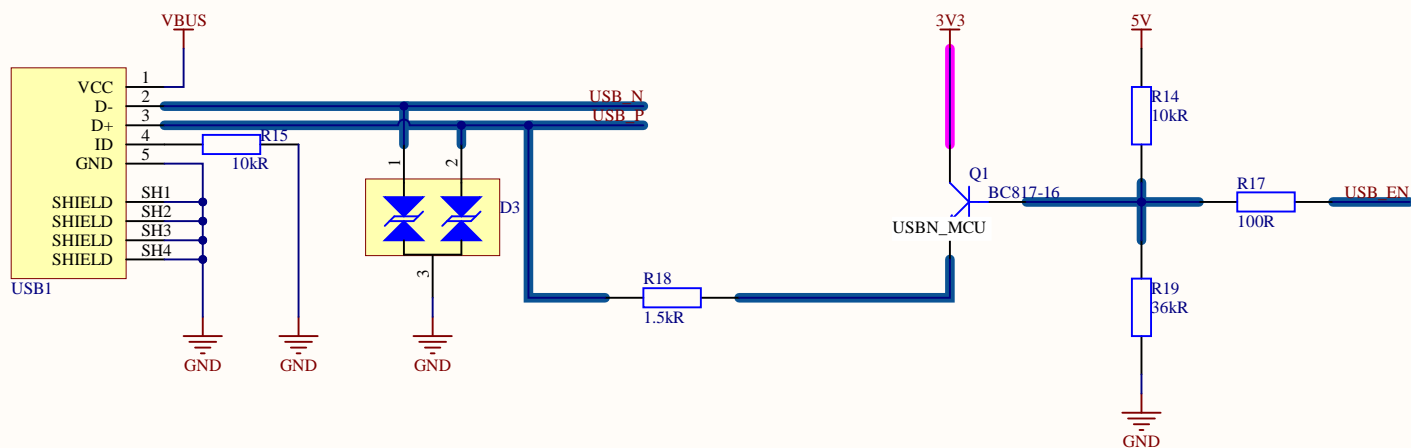
ECS-80-10-30B-CWN-TR is selected.
fs=8Mhz
CL=10pF
CL1=CL2= 12pF
(CLx=2*(CL-Cp)
where Cp is selected 4pF



OSCILLATOR

DOSYA ADI / FILE NAME MCU.SchDoc		TANIM / DESCRIPTION STLINK_V2	
Aslı Kurt		HAZIRLAYAN / PREPARED BY Aslı Kurt	
		YAYIN TARİHİ / REL. DATE 30.10.2024	BOYUT / SIZE A3
		SAYFA / SHEET 4 / 5	

USB CONNECTION - MINI B



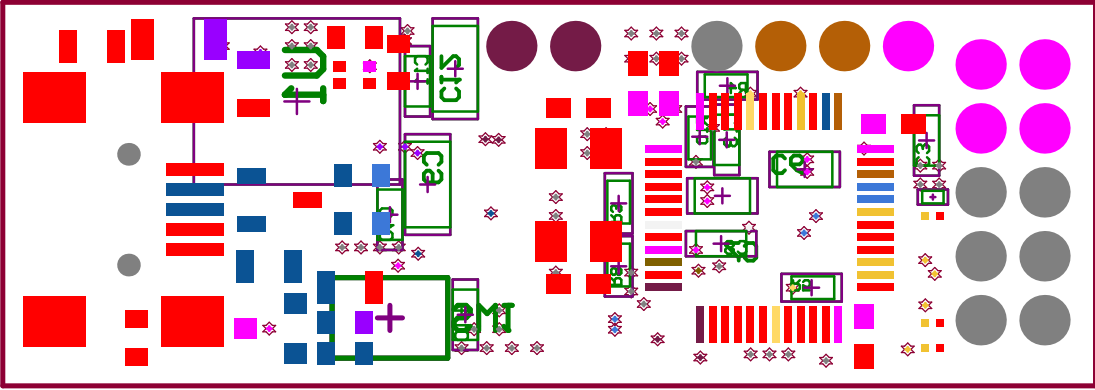
Use of TVS diode is recommended to protect USB connections against to sudden voltage rise. It aims to suppress excess voltage.

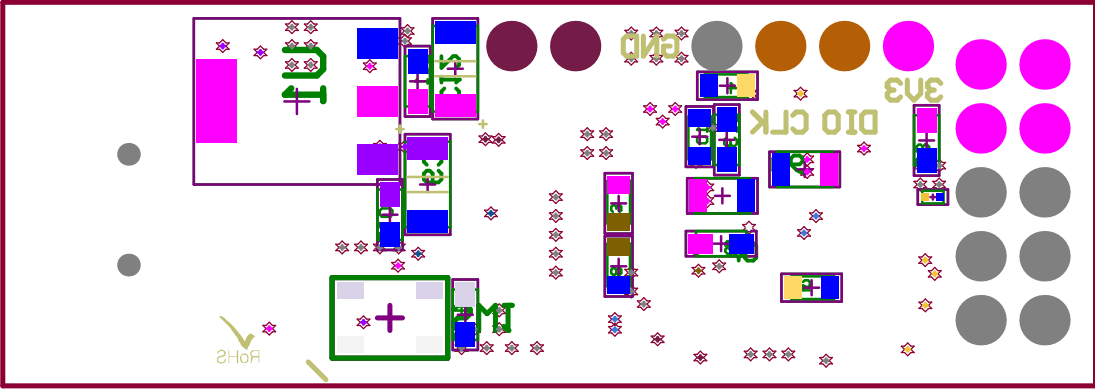
USB MINI B

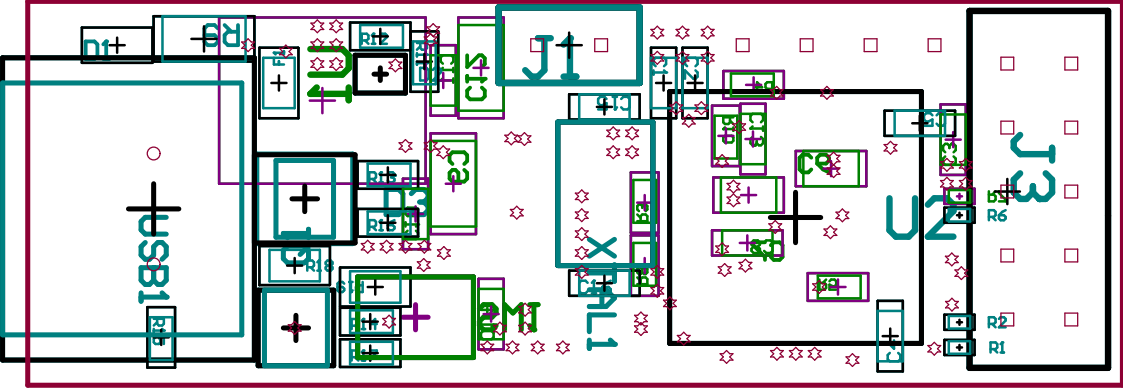
Thermistor works as fuse on the circuit. Rise of voltage causes rise of temperature. As temperature rise also the resistance rise. After a while, the circuit becomes open. When the negative condition disappered, the fuse become operate again. This circuit element aims to protect the circuit.

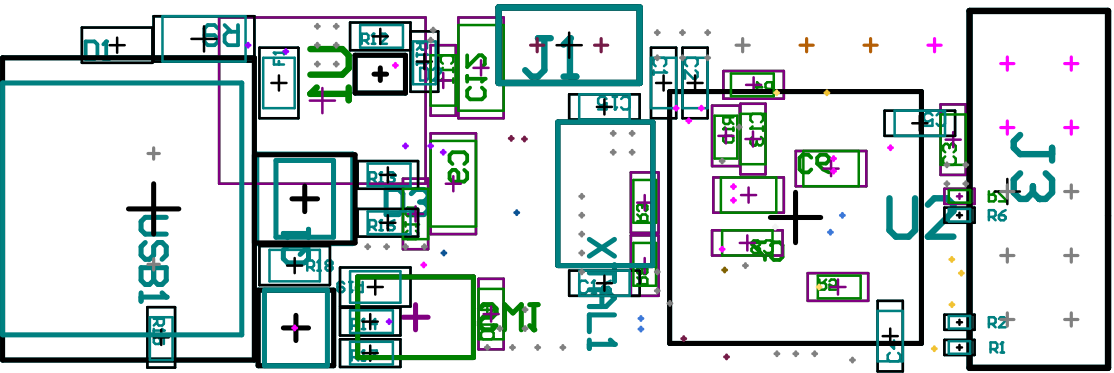
THERMISTOR PTC

DOSYA ADI / FILE NAME USB.SchDoc		TANIM / DESCRIPTION STLINK_V2		
Aslı Kurt		HAZIRLAYAN / PREPARED BY Aslı Kurt		
		YAYIN TARİHİ / REL. DATE 30.10.2024	BOYUT / SIZE A3	SAYFA / SHEET 5 / 5









Comment	Description	Designator	Footprint	LibRef	Quantity
O603C104KSRACU	CAP CER 100nF±10% 0603 SMD	C1, C2, C3, C4, C5, C10, C11, C13, C14	CAP_0603	CAP CER 100nF 0603	9
CL21A475KQNNNE	CAP CER 4.7uF±10% 0805	C6	CAP_0805	CAP CER 4.7uF 0805	1
CL21B105KBNNE	CAP CER 1uF±10% 0805	C7	CAP_0805	CAP CER 1uF 0805	1
O603B103K16OCT	CAP CER 10nF±10% 0603	C8	CAP_0603	CAP CER 10nF 0603	1
T491A106K010AT	Cap Tant Solid 10uF 10V ACASE 10%(3.2 X 1.6 X 1.6mm) SMD 3216-18.4 Ohm 125 C T/R	C9, C12	CAP_1206_TANT	CAP TANT 10uF 1206	2
CO0603FRNPO8BN12 0	Multilayer Ceramic Capacitor, 12 pF, 50 V, 1/2±1%, COG (NP0), 0603 [1608 Metric]	C15, C16	CAP_0603	CAP CER 12pF 0603	2
LTST-C170KFKT	LED Uni-Color Orange 611nm 2-Pin Chip LED T/R LED ORANGE CLEAR 0805 SMD	D1	LED_ORANGE_0805	LED ORANGE 0805	1
APHB16080CGKSURK2	Green/Red 0603 130° Clear 50/250 mcd 2.1/1.95 V Surface Mount Flat Top LED	D2	LED_INDP_GREENRED _0603	LED_INDP_GREENRED _0603	1
SM712	7V/12V Tvs, Package SOT-23, Tvs A	D3	SOT-23	SM712	1
PRG21BC1R0MM1RA	Thermistor PTC 1 Ohm 20% 2-Pin 0805 Surface Mount Solder Pad Embossed T/R	F1	FUSE_0805	PRG21BC1R0MM1RA	1
61300211121		J1	2x1 Male Header 2.54mm	2x1 Male Header 2.54mm	1
2.54mm		J2	4x1 Pinout	4x1 Pinout	1
SBH11-PBPC-D05-RA BK	Conn Shrouded Header (4 Sides) HDR 10 POS 2.54mm Solder RA Side Entry Thru- Hole	J3	5x2 Male Header 2.54mm Shrouded - 4 Wall	5x2 Male Header 2.54mm Shrouded - 4 Wall	1
BC817-16	ON Semi BC817- 16LTI1G NPN Bipolar Transistor, 0.5 A, 45 V, 3-Pin SOT-23	Q1	SOT23	BC817-16	1
AO0201FR-0722RL	SMD Chip Resistor, 22 Ohm, ±1%, 50 mW, 0201 [0603 Metric], Thick Film, General Purpose	R1, R2, R6, R7	RES_0201	RES 22 OHM 0201	4
RC0603JR-074K7L	RES 4K7±5% OHM 0603 SMD	R3, R8	RES_0603	RES 4K7 OHM 0603	2
RC0603FR-0710KL	RES 10K±1% OHM 0603 SMD	R4, R5, R10, R14, R15	RES_0603	RES 10K OHM 0603	5
RC1206FR-07680RL	SMD Chip Resistor, 680 Ohm, 1/2±1%, 250 mW, 1206 [3216 Metric], Thick Film, General Purpose	R9	RES_1206	RES 680 OHM 1206	1
BRH3EF3300V	RES, 330R, 1%, 0.125W, 0603;	R11, R12	RES_0603	RES 330 OHM 0603	2
RC0603JR-0715RL	RES 15±5% OHM 0603 SMD	R13, R16	RES_0603	RES 15 OHM 0603	2
RC0603JR-07100RL	RES 100±5% OHM 0603 SMD	R17	RES_0603	RES 100 OHM 0603	1
RC0805FR-071KSL	SMD Chip Resistor, 1.5 kOhm, 1/2±1%, 125 mW, 0805 [2012 Metric], Thick Film, General Purpose	R18	RES_0805	RES 1K5 OHM 0805	1
RC0805FR-0736KL	SMD Chip Resistor, 36 kOhm, ±1%, 125 mW, 0805 [2012 Metric], Thick Film, General Purpose	R19	RES_0805	RES 36K OHM 0805	1
PTS810 SJG 250 SMTR LFS	Switch Tactile N.O. SPST Button J-Bend 0.05A 16VDC 1000000 Cycles 3.92N SMD T/R	SW1	BUTTON_SMD_BLUE	PTS810 SJG 250 SMTR LFS	1
LM1117MPX-33NCPB	800-mA 15-V linear voltage regulator; 4- SOT-223 0 to 125	U1	SOT223	LM1117MPX-33NCPB	1
STM32F103C8T6	ARM Cortex-M3 STM32 F1 Microcontroller 32- Bit 72MHz 64kB FLASH LQFP48 STM32F103C8T6	U2	LQFP48-STM	STM32F103C8T6	1
690-005-299-043	Conn Mini USB 2.0 Type B RCP 5 POS 0.8mm Solder RA SMD 5 Terminal 1 Port	USB1	MINI_USB_B	690-005-299-043	1
ECS-80-10-30B-CWVN- TR	Crystal 8MHz±10ppm (ToI) ±15ppm (Stability) 10pF FUND 100Ohm 4- Pin Mini-SMD T/R	XTAL1	4-SMD, No Lead	ECS-80-10-30B-CWVN- TR	1

Design Rules Verification Report

Filename : C:\Users\asli\Desktop\Hardware Design\Project Files\InProgress\PCB_Project_

Warnings 0
Rule Violations 3

Warnings	
Total	0

Rule Violations	
Clearance Constraint (Gap=0.2mm) (All),(All)	0
Short-Circuit Constraint (Allowed=No) (All),(All)	0
Un-Routed Net Constraint ((All))	0
Modified Polygon (Allow modified: No), (Allow shelved: No)	0
Width Constraint (Min=0.1mm) (Max=30mm) (Preferred=0.7mm) (All)	0
Power Plane Connect Rule(Direct Connect)(Expansion=0.508mm) (Conductor Width=0.254mm) (Air Gap=0.254mm)	0
Hole Size Constraint (Min=0.15mm) (Max=6.3mm) (All)	0
Hole To Hole Clearance (Gap=0.1mm) (All),(All)	0
Minimum Solder Mask Sliver (Gap=0.1mm) (All),(All)	1
Silk To Solder Mask (Clearance=0.15mm) (IsPad),(All)	1
Silk to Silk (Clearance=0.15mm) (All),(All)	0
Net Antennae (Tolerance=0mm) (All)	0
Board Clearance Constraint (Gap=0mm) (All)	1
Height Constraint (Min=0mm) (Max=25.4mm) (Preferred=12.7mm) (All)	0
Total	3

Minimum Solder Mask Sliver (Gap=0.1mm) (All),(All)	
Minimum Solder Mask Sliver Constraint: (0.025mm < 0.1mm) Between Pad J2-4(28.39mm,13.5mm) on Multi-Layer And Pad	

Silk To Solder Mask (Clearance=0.15mm) (IsPad),(All)	
Silk To Solder Mask Clearance Constraint: (Collision < 0.15mm) Between Pad R12-2(14.75mm,13.85mm) on Top Layer And Track	

Board Clearance Constraint (Gap=0mm) (All)	
Board Outline Clearance(Outline Edge): (0.143mm < 0.2mm) Between Board Edge And Track (12.15mm,0.95mm)(12.857mm,0.243mm) on Bottom	

Electrical Rules Check Report

Class	Document	Message
		Successful Compile for ST LINKV2.PrjPcb